imall

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Data Sheet

Description/Applications

Avago Technologies's HSMP-389Z is optimized for switching applications where low resistance at low current and low capacitance are required. It is housed in a low cost, industrial standard surface mount package - SOD-323. This package offers customers who already use them in SOT-23 and SOT-323 packages, a logical transition to a smaller package outline to accommodate end product design with limited board space.

A SPICE model is not available for PIN diodes as SPICE does not provide for a key PIN diode characteristic -- carrier lifetime.

Package Marking and Pin Connections



Note:

Package marking provides orientation and identification

"E" = Device Code

"?" = Month code indicates the month of manufacture

Features

- 2 Leads Surface Mount Package
- Switching
 - Low Capacitance
- Low Resistance at Low Current
- Tape and Reel Options Available
- Low Failure in Time (FIT) Rate
- MSL 1 & Lead Free



Symbol	Parameter	Unit	Max Rating
l _f	Forward Current (1 µs Pulse)	Amp	1
P _{IV}	Peak Inverse Voltage	V	100
T _j	Junction Temperature	٥C	150
T _{stg}	Storage Temperature	٥C	-60 to 150
θ _{jb}	Thermal Resistance ^[2]	°C/W	135

Table 1. Absolute Maximum Ratings [1] at $Tc = +25^{\circ}C$

Notes:

1. Operation in excess of any one of these conditions may result in permanent damage to the device.

2. Thermal Resistance is measured from junction to board using IR method.

Table 2. Electrical Specifications at $Tc = +25^{\circ}C$

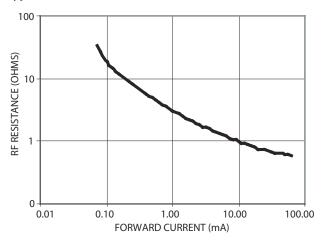
	Minimum Breakdown Voltage V _{BR} (V)	Maximum Total Resistance R _s (Ohm)	Maximum Total Capacitance $C_{\tau} \ (pF)$
	100	2.5	0.30
Test Conditions	$V_{R} = V_{BR}$ Measure $I_{R} \le 10$ uA	I _F = 5mA f = 100 MHz	$V_{R} = 5V$ f = 1MHz

Note : Rs parameter is tested under AQL 1.0

Table 3. Typical Parameters at $Tc = +25^{\circ}C$

	Series Resistance R _s (Ohm)	Carrier Lifetime τ (ns)	Total Capacitance $C_{ au}$ (pF)
	3.8	200	0.20
Test Conditions	I _F = 1 mA f = 100 MHz	$I_F = 10mA$ $I_R = 6mA$	$V_{R} = 5V$ f = 1MHz

Typical Performance Curves at $Tc = +25^{\circ}C$



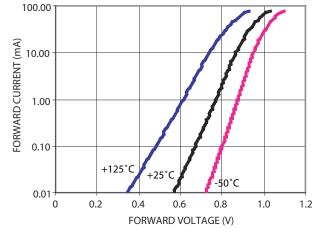
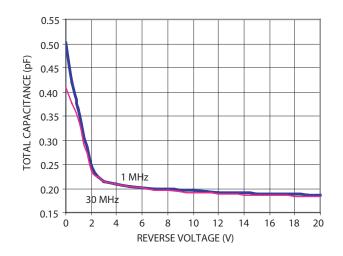


Figure 1. RF Resistance vs. Forward Bias Current





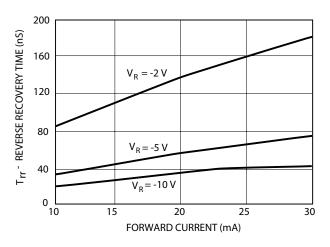


Figure 5. Typical Reverse Recovery Time vs. Reverse Voltage

Figure 2. Forward Current vs. Forward Voltage

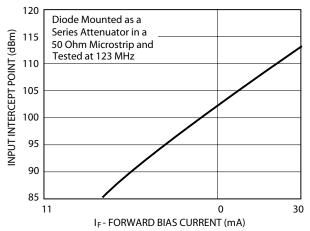
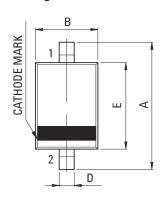
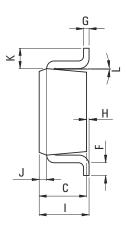


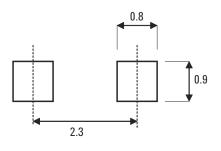
Figure 4. 2nd Harmonic Input Intercept Point vs. Diode RF Resistance

Package Outline and Dimension

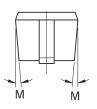




PCB Footprint

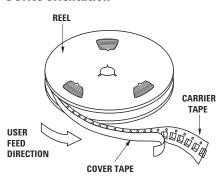


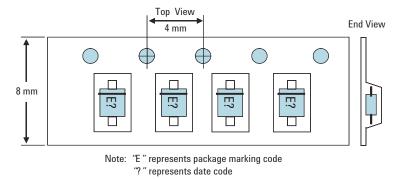
Dimension in mm



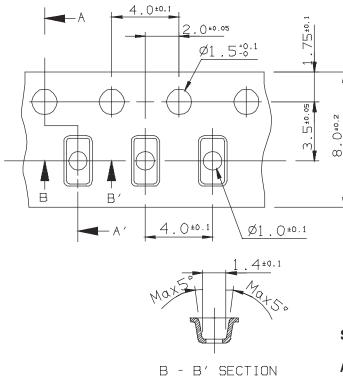
DIM	MILLIMETERS	
Α	2.50 ±0.2	
В	1.25 ±0.05	
С	0.90 ±0.05	
D	0.30+0.06/-0.04	
Е	1.70 ±0.05	
F	MIN 0.17	
G	0.126 ±0.03	
Н	0~0.1	
Ι	1.0 MAX	
J	0.15 ±0.05	
К	0.4	
L	2°+4/-2	
M4	~6°	

Device Orientation





Tape Dimensions



0.25±0.02

A - A' SECTION

Specification < Unit: mm >

A. hole pitch : 50 Pitch Tolerance : 200 \pm 0.3

Part Number Ordering Information

Part number	No. of Units	Container
HSMP-389Z-BLKG	100	Anti-static bag
HSMP-389Z-TR1G	3000	7" reel

For product information and a complete list of distributors, please go to our web site: www.a

www.avagotech.com

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